MYC-CZU3EG/4EV/5EV-V2 CPU Module

- > Xilinx Zynq UltraScale+ ZU3EG/4EV/5EV MPSoC based on 1.2GHz Quad Arm Cortex-A53 (up to 1.5GHz) and 600MHz Dual Cortex-R5 Cores
- 4GB DDR4 SDRAM (64bit, 2400MHz)
- ➤ 4GB eMMC Flash, 128MB QSPI Flash
- On-board Gigabit Ethernet PHY, USB PHY, Power Module and Clock Generator
- > Two 0.5mm pitch 160-pin Samtec High-Speed Headers for Board-to-Board Connections
- Ready-to-Run PetaLinux 2020.1
- Supports Xilinx Vitis Software Development Platform



Figure 1-1 MYC-CZU3EG/4EV/5EV-V2 CPU Module

The MYC-CZU3EG/4EV/5EV-V2 CPU Module is a powerful MPSoC System-on-Module (SoM) based on Xilinx Zynq UltraScale+ ZU3EG / ZU4EV/ZU5EV which features a 1.2 GHz quad-core ARM Cortex-A53 64-bit application processor, a 600MHz dual-core real-time ARM Cortex-R5 processor, a Mali400 MP2 embedded GPU and rich FPGA fabric. It has 4GB DDR4, 4GB eMMC and 128MB QSPI Flash default memory configuration on board as well as integrated Ethernet PHY, USB PHY and Power Module to provide control and processing capabilities as a minimum embedded system. It offers easy access to signals carried to or from the MPSoC through two 0.5mm pitch 160-pin Razor Beam High-Speed Sockets. It is ready to run PetaLinux 2020.1 and support Xilinx Vitis Software development platform, which comes with detailed documentations and software package.

Developers can simply design their own base board using the MYC-CZU3EG/4EV/5EV-V2 as the embedded controller which can help save time and reduce cost. MYIR has a reference base board design for customer evaluation and prototype. The whole development board MYD-CZU3EG/4EV/5EV-V2 takes full features of the Zynq UltraScale+ XCZU3EG-1SFVC784E/XCZU4EV-1SFVC784I/XCZU5EV-2SFVC784I MPSoC to have explored a robust set of peripherals for a wide variety of applications including the Internet, cloud computing, Data center, Machine Vision, Military facilities, Flight navigation and other embedded applications.

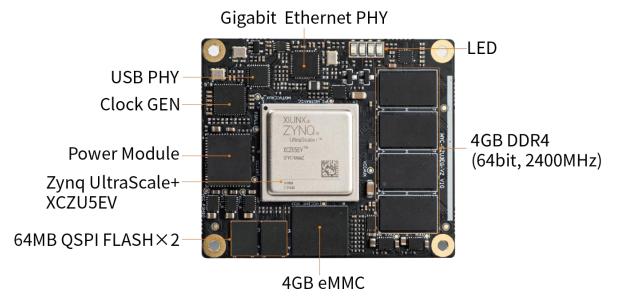


Figure 1-2 MYC-CZU3EG/4EV/5EV-V2 CPU Module

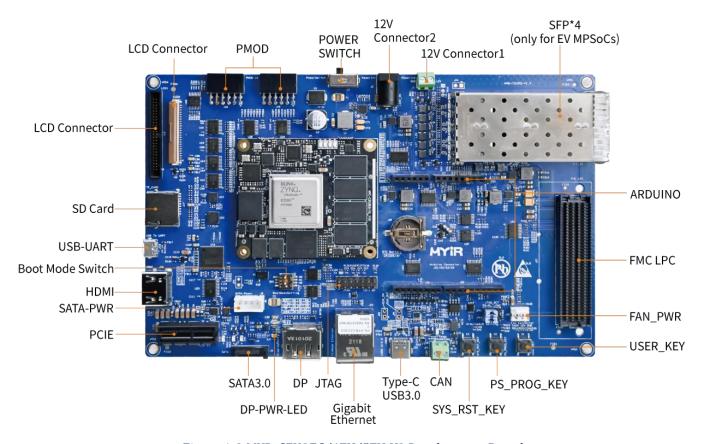


Figure 1-3 MYD-CZU3EG/4EV/5EV-V2 Development Board

Hardware Specification

Zynq® UltraScale+™ MPSoC devices provide 64-bit processor scalability while combining real-time control with soft and hard engines for graphics, video, waveform, and packet processing. Built on a common real-time processor and programmable logic equipped platform, three distinct variants include dual application processor (CG) devices, quad application processor and GPU (EG) devices, and video codec (EV) devices.

	CG Devices	EG Devices	EV Devices
Application Processor	Dual-core ARM® Cortex™-A53 MPCore™ up to 1.3GHz	Quad-core ARM Cortex-A53 MPCore up to 1.5GHz	Quad-core ARM Cortex-A53 MPCore up to 1.5GHz
Real-Time Processor	Dual-core ARM Cortex-R5 MPCore up to 533MHz	Dual-core ARM Cortex-R5 MPCore up to 600MHz	Dual-core ARM Cortex-R5 MPCore up to 600MHz
Graphics Processor		Mali™-400 MP2	Mali™-400 MP2
Video Codec			H.264 / H.265
Programmable Logic	103K–600K System Logic Cells	103K–1143K System Logic Cells	192K–504K System Logic Cells
Applications	Sensor Processing & Fusion Motor Control Low-cost Ultrasound Traffic Engineering	 Flight Navigation Missile & Munitions Military Construction Secure Solutions Networking Cloud Computing Security Data Center Machine Vision Medical Endoscopy 	Situational Awareness Surveillance/Reconnaissance Smart Vision Image Manipulation Graphic Overlay Human Machine Interface Automotive ADAS Video Processing Interactive Display

Figure 1-4 Zyng UltraScale+ MPSoCs

The Zynq UltraScale+ family provides footprint compatibility to enable users to migrate designs from one device to another. Any two packages with the same footprint identifier code (last letter and number sequence) are footprint compatible. MYIR is using the **XCZU3EG-1SFVC784E** / **XCZU4EV-1SFVC784I** / **XCZU5EV-2SFVC784I** MPSoC by default, the C784 package covers the widest footprint compatibilities that enable users to select devices among CG, EG and EV.

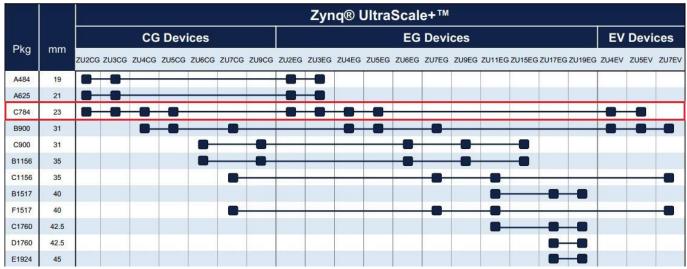
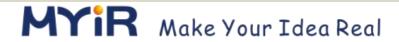


Figure 1-5 Zynq® UltraScale+™ MPSoC Device Migration Table



MYIR supply the MYC-CZU3EG/4EV/5EV-V2 CPU Modules with XCZU3EG, XCZU4EV or XCZU5EV MPSoC as options. The main features for the MPSoC devices are summarized as below.

Device	XCZU2CG	XCZU3CG	XCZU3EG	XCZU4EV	XCZU5EV	
Logic cells (k)	103	154	154	192	256	
CLB Flip-Flops (K)	94	141	141	176	234	
CLB LUTs (K)	47	71	71	88	117	
Block RAM (Mb)	5.3	7.6	7.6	4.5	5.1	
UltraRAM (Mb)	-	-	-	13.5	18.0	
DSP Slices	240	360	360	728	1,248	
GTX transceivers	PS-GTR4x (6Gb/s)	PS-GTR4x (6Gb/s)	PS-GTR4x (6Gb/s)	PS-GTR4x (6Gb/s), GTH4x (16.3Gb/s)	PS-GTR4x (6Gb/s), GTH4x (16.3Gb/s)	
Processor Units						
Application Processor Unit	Dual-core ARM®Quad-core ARM® Cortex™-A53 MPCCortex™-A53 MPCore™1.5GHzup to 1.3GHz		PCore™ up to			
Memory w/ECC	L1 Cache 32KB I / D per core, L2 Cache 1MB, on-chip Memory 256KB					
Real-Time Processor Unit	Dual-core ARM Cortex-R5 MPCore™ up to 600MHz					
Memory w/ECC	L1 Cache 32KB I / D per core, Tightly Coupled Memory 128KB per core					
Graphics Processing Unit	-	-	Mali™-400 MP2 up to 667MHz			
Video Codec	-	-	-	H.264 / H.265		
Memory L2 Cache	64KB					
External Memory, Connectiv	ity, Integrate	d Block Funct	ionality			
Dynamic Memory Interface	x32/x64: DDR4, LPDDR4, DDR3, DDR3L, LPDDR3 with ECC					
Static Memory Interfaces	NAND, 2x Quad-SPI					
High-Speed Connectivity	PCIe® Gen2 x4, 2x USB3.0, SATA 3.1, DisplayPort, 4x Tri-mode Gigabit Ethernet					
General Connectivity	2 x USB 2.0, 2 x SD/SDIO, 2 x UART, 2 x CAN 2.0B, 2 x I2C, 2 x SPI, 4 x 32b GPIO					
Power Management	Full / Low / PL / Battery Power Domains					
Security	RSA, AES, and SHA					
AMS - System Monitor	10-bit, 1MSPS – Temperature and Voltage Monitor					

Table 1-1 MPSoC device selection guide

MYiR Make Your Idea Real

The MYC-CZU3EG/4EV/5EV-V2 CPU Module takes full features of the Xilinx Zynq UltraScale+ ZU3EG/4EV/5EV MPSoC to bring out most of the processor signals through two 0.5mm pitch 160-pin Razor Beam High-Speed headers. The main features are characterized as below:







Figure 1-7 MYC-CZU3EG/4EV/5EV-V2 Bottom-view

Mechanical Parameters

- ✓ Dimensions: 60.00 mm x 52.00 mm
- ✓ PCB Layers: 12-layer design
- ✓ Power supply: 3.3V
- ✓ Working temp.: 0~70 Celsius (commercial grade, MYC-CZU3EG-V2),
 - -40~85 Celsius (industrial grade, MYC-CZU4EV/5EV-V2)

MPSoC

- ✓ Xilinx Zynq UltraScale+ XCZU3EG-1SFVC784E / XCZU4EV-1SFVC784I / XCZU5EV-2SFVC784I MPSoC
 - 1.2GHz 64 bit Quad-core ARM® Cortex™-A53
 - 600MHz Dual-core ARM® Cortex[™]-R5 processor
 - 667MHz ARM Mali™-400MP2 Graphics Processor
 - 16nm FinFET+ FPGA fabric

Memory

- √ 4GB DDR4 SDRAM (64bit, 2400MHz)
- ✓ 4GB eMMC Flash
- ✓ 128MB QSPI Flash

Peripherals and Signals Routed to Pins

- ✓ Gigabit Ethernet PHY
- ✓ USB PHY
- ✓ Power Module
- ✓ Clock Generator
- ✓ Watchdog
- ✓ Four LEDs
 - One yellow LED for ERROR_STATUS indicator (indicate a secure lockdown state)
 - One yellow LED for ERROR_OUT indicator (Asserted for accidental power loss, hardware error)
 - One green LED for PS_Done indicator (indicate the pl configuration is done)
 - One green LED for PS_INIT indicator (indicate the ps is initialized after a power-on reset)



- ✓ Two 0.5mm pitch 160-pin Razor Beam High-Speed headers bring out
 - 4 PS GTR transceivers along with 2 GTR reference clock inputs
 - PS JTAG interface, USB 2.0 interface, Gigabit Ethernet interface and etc.
 - 4 PL GTH transceivers along with 1 GTH reference clock input (only for Zynq UltraScale+ EV Devices)
 - 156 user PL I/O pins

Function Block Diagram

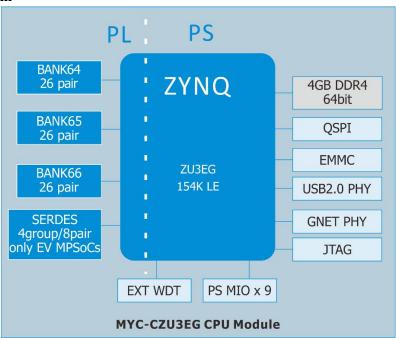


Figure 1-8 Function Block Diagram of MYC-CZU3EG/4EV/5EV-V2

Dimension Chart

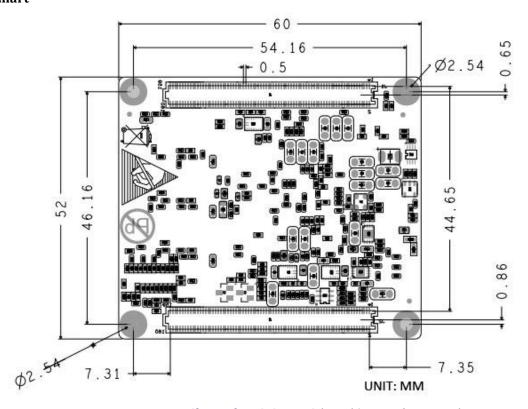


Figure 1-9 Dimension Chart of MYC-CZU3EG/4EV/5EV-V2 (Top-view)



Software Features

The MYC-CZU3EG/4EV/5EV-V2 CPU Module is preloaded with PetaLinux 2020.1. MYIR provides software package in product disk along with the goods delivery. The software package features as below:

Item	Features	Description	Remark		
Cross	gcc9.2.0	gcc version 9.2.0			
compiler	gcc 5.2.1	gcc version 5.2.1 (Linaro GCC5.2)			
Boot program	BOOT.BIN	First boot program including FSBL, u-boot2020.01	Source code provided		
Linux Kernel	Linux 5.4.0	Customized kernel for MYD-CZU3EG/4EV/5EV-V2 Board	Source code provided		
	SFP & SFP+	SFP driver and SFP+ driver (only for CZU4EV/5EV)	Source code provided		
	VCU	VCU driver (only for CZU4EV/5EV)	Source code provided		
	USB Host	USB2.0/USB3.0 Host driver	Source code provided		
	Ethernet	Gigabit Ethernet driver	Source code provided		
	MMC/SD/TF	MMC/SD/TF card driver	Source code provided		
	QSPI Flash	QSPI Flash driver	Source code provided		
	PCI-E	PCI-E driver	Source code provided		
	CAN	CAN driver	Source code provided		
	DP	DP display driver	Source code provided		
	HDMI	HDMI display driver	Source code provided		
Drivers	LCD	LCD display driver	Source code provided		
	Button	Button driver	Source code provided		
	UART	Uart rs232 driver	Source code provided		
	I2C	I2C driver	Source code provided		
	LED	LED driver	Source code provided		
	GPIO	GPIO driver	Source code provided		
	QSPI	QSPI Flash MT25QU512ABB driver	Source code provided		
		TSC2007 resistive touch screen driver	Source code provided		
	Touch Screen	FT5X0X capacitive touch screen driver	Source code provided		
	SATA	SATA HD driver	Source code provided		
	Watch dog	Watch dog driver	Source code provided		
Example	Including Button, LED, CAN, Rs232, Socket examples				
File System	Ramdisk	Ramdisk system image	File System		
	Rootfs.tar	Buildroot, including QT	Source code provided		
Petalinux	Petalinux2020.1	Supports Xilinx development tools for PetaLinux 2020.1 and provides complete customized Linux BSP in source code including kernel, uboot, filesystem, etc. Supports Xilinx Vitis development.			

Table 1-2 Software Features of MYC-CZU3EG/4EV/5EV-V2



Order Information

Item	Pagking List		
	Packing List		
MYC-CZU3EG-V2 CPU Module	> MYC-CZU3EG-V2 CPU Module		
(Part No.: MYC-CZU3EG-V2-4E4D-1200-C)			
MYC-CZU4EV-V2 CPU Module	> MYC-CZU4EV-V2 CPU Module		
(Part No.: MYC-CZU4EV-V2-4E4D-1200-I-FAN)	(installed with heatsink)		
MYC-CZU5EV-V2 CPU Module	> MYC-CZU5EV-V2 CPU Module		
(Part No.: MYC-CZU5EV-V2-4E4D-1200-I-FAN)	(installed with heatsink)		
MYD-CZU3EG-V2 Development Board	> One MYD-CZU3EG/4EV/5EV-V2 Development		
(Part No.: MYD-CZU3EG-V2-4E4D-1200-C)	Board (including the base board and CPU module		
(with installed active heatsink)		
MYD-CZU4EV-V2 Development Board	> One HDMI cable		
(Part No.: MYD-CZU4EV-V2-4E4D-1200-C)	One 12V/5A Power adapter		
MYD-CZU5EV-V2 Development Board	One 1.2m Mini USB2.0 cableOne USB A3.0 to Type-C cable Adapter		
(Part No.: MYD-CZU5EV-V2-4E4D-1200-C)	> One 16GB TF card		
MY-LCD70TP LCD Module	7-inch LCD Module with resistive touch screen		
(Part No.: MY-TFT070RV2)			
MY-LCD70TP-C LCD Module			
(Part No.: MY-TFT070CV2)	7-inch LCD Module with capacitive touch screen		
MY-CAM002U Camera Module	USB Camera Module		
(Part No.: MY-CAM002U)			
Active heatsink (Part No.: 2310100065) - 60mm * 52mm * 14.5mm			
- aluminum heatsink with fan			
- silicon pad			
Samtec 0.5mm pitch 160-pin Razor Beam			
High-Speed Socket			
(Part No.: SS5-80-3.50-L-D-K-TR)			
Matching with the headers on MYIR's			
MYC-CZU3EG/4EV/5EV-V2 CPU Module			



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